AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN

FREE

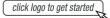


## Vishay General Semiconductor

# **Surface Mount Schottky Barrier Rectifier**

# eSMP® Series Top view Bottom view SMF (DO-219AB) Cathode Anode

## **DESIGN SUPPORT TOOLS**





PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	2.0 A		
V <sub>RRM</sub>	100 V		
I <sub>FSM</sub>	50 A		
$V_F$ at $I_F$ = 2.0 A ( $T_A$ = 125 °C)	0.63 V		
T <sub>J</sub> max.	175 °C		
Package	SMF (DO-219AB)		
Circuit configuration	Single		

#### **FEATURES**

- Low profile package
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

## **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

#### **MECHANICAL DATA**

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SS2FH10	UNIT	
Device marking code		210		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V	
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub> (1)	2.0	Α	
Non-repetitive peak forward surge current 8.3 ms single half sine-wave at $T_{J\ (init)}=25\ ^{\circ}C$	I <sub>FSM</sub>	50	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C	

#### Note

<sup>(1)</sup> Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 25 °C	- V <sub>F</sub> <sup>(1)</sup>	0.71	-	V
	I <sub>F</sub> = 2.0 A			0.77	0.86	
	I <sub>F</sub> = 1.0 A	- T <sub>A</sub> = 125 °C		0.56	-	
	I <sub>F</sub> = 2.0 A			0.63	0.70	
Reverse current	V 100 V	$T_A = 25  ^{\circ}\text{C}$ $T_A = 125  ^{\circ}\text{C}$ $I_R^{(2)}$	-	5		
	$V_{R} = 100 \text{ V}$		IR (=)	65	160	- μΑ
Typical junction capacitance	4.0 V, 1 MHz		CJ	70	-	pF

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 5 \text{ ms}$ 

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °c unless otherwise noted)				
PARAMETER	METER SYMBOL SS2FH10		UNIT	
Typical thermal registance	R <sub>0</sub> JA (1)(2)(3)	125	°C/W	
Typical thermal resistance	R <sub>0JM</sub> (2)(3)	21	- C/VV	

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Device mounted on FR4 PCB, 2 oz. standard footprint

 $^{(3)}$  Thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SS2FH10-M3/H	0.015	Н	3000	7" diameter plastic tape and reel
SS2FH10-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SS2FH10HM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel
SS2FH10HM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel

### Note

(1) AEC-Q101 qualified



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## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

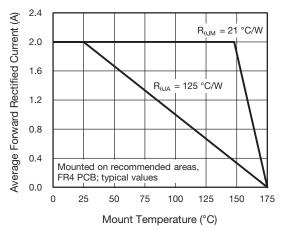


Fig. 1 - Typical Forward Current Derating Curve

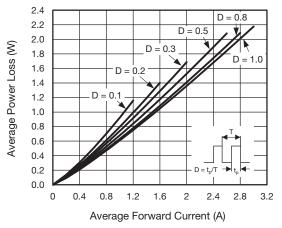


Fig. 2 - Forward Power Loss Characteristics

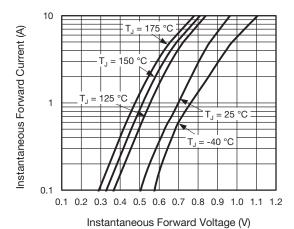


Fig. 3 - Typical Instantaneous Forward Characteristics

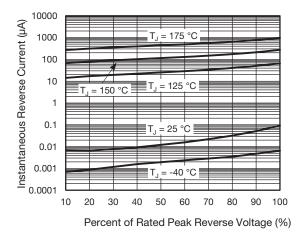


Fig. 4 - Typical Reverse Leakage Characteristics

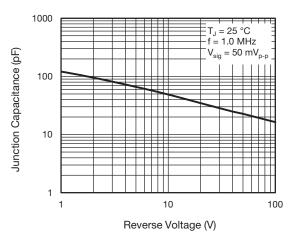


Fig. 5 - Typical Junction Capacitance

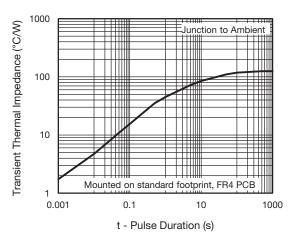
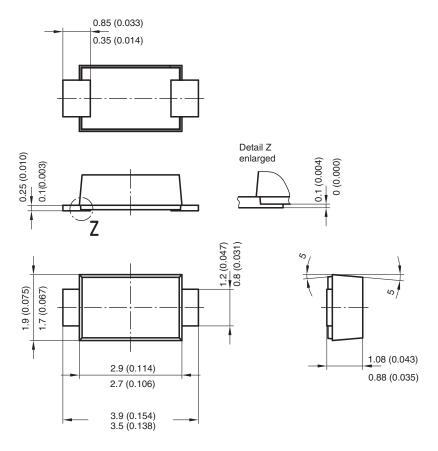


Fig. 6 - Typical Transient Thermal Impedance

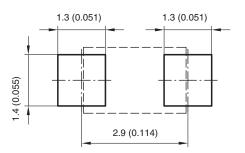


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## PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



### Foot print recommendation:



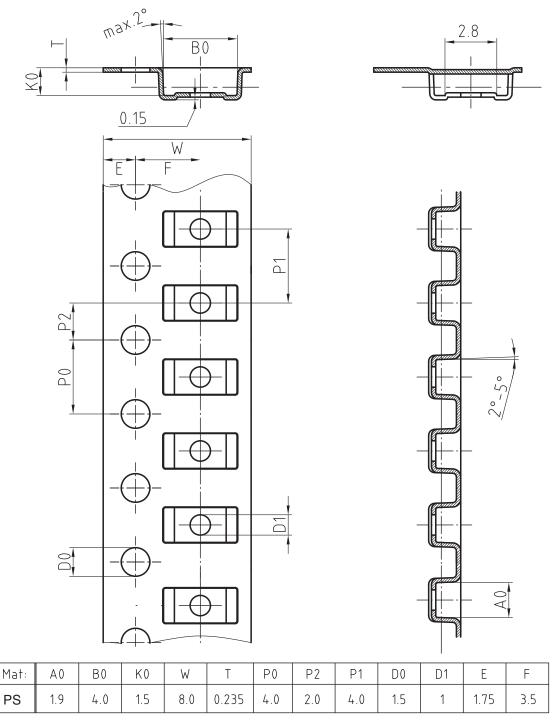
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## **BLISTERTAPE DIMENSIONS** in millimeters: **SMF (DO-219AB)**



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